

# I-V & CCE results of Neutron Irradiated GaN Detectors

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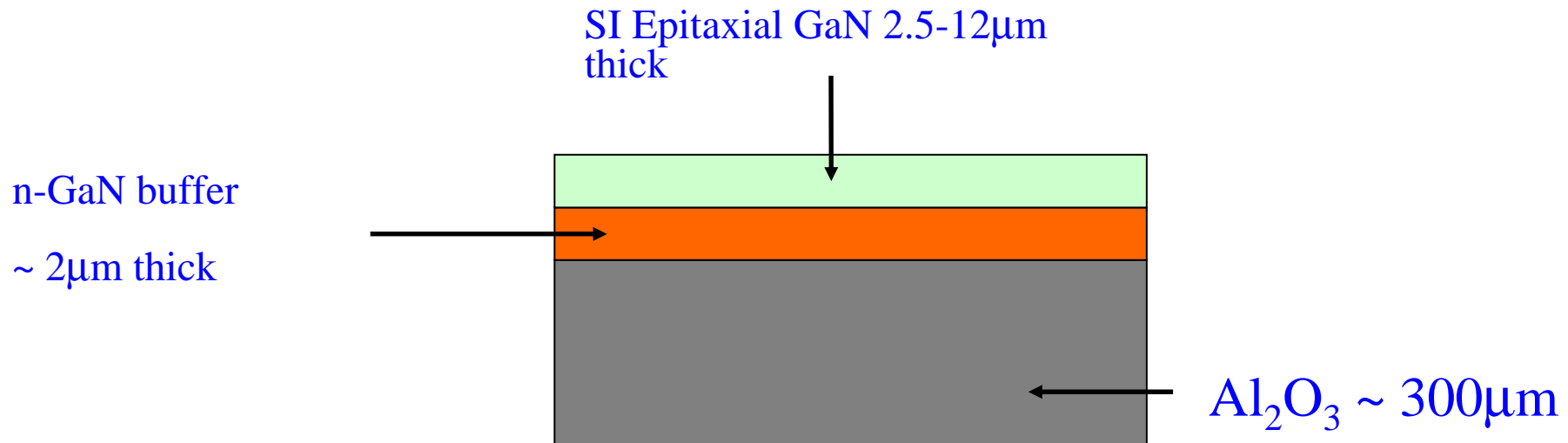


# Outline

- Material studied
- Detector fabrication
- Detector characterisation
  - I-V & CCE measurements
- CCE experimental set-up
- Irradiations performed
- I-V & CCE results
- Inductively Coupled Plasma (ICP) etching of GaN
  - I-V, C-V and CCE results
- Conclusions & work in progress

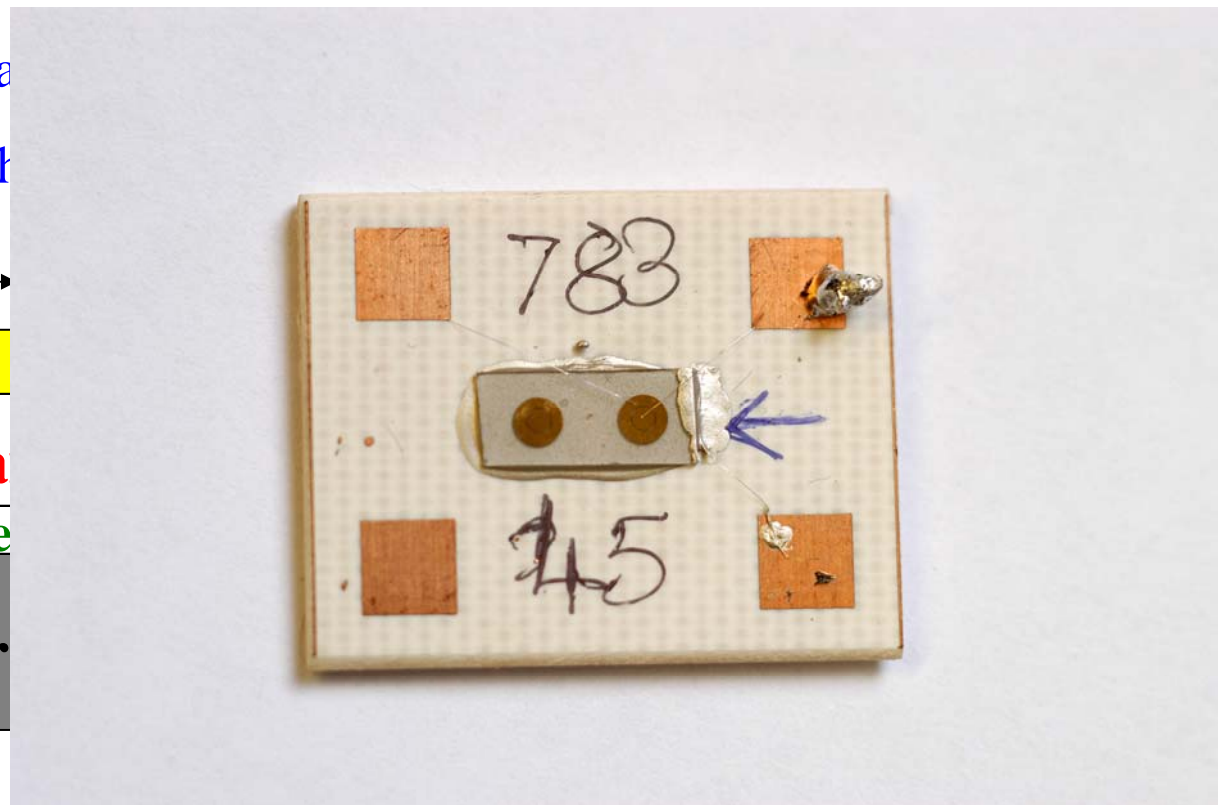
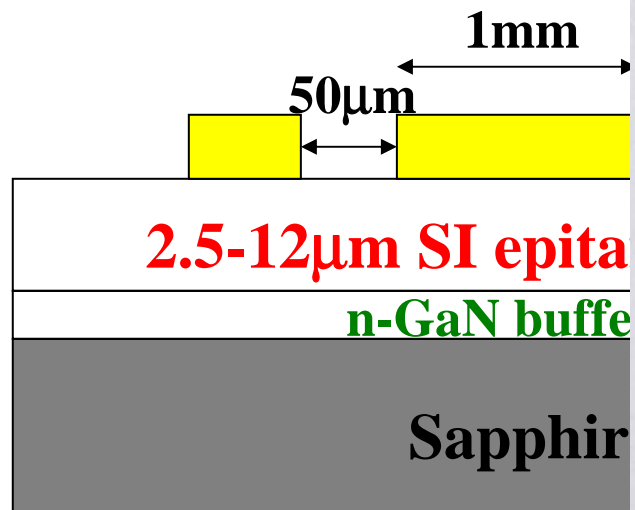
# GaN Material Studied

- 3 GaN materials investigated (all grown by MOCVD)
  - 2 GaN wafers obtained from Tokushima University, Japan.  
(2.5 $\mu\text{m}$  semi-insulating epi GaN, known as “36 GaN” & “45 GaN”)
  - 1 GaN wafer obtained from LUMILOG, France  
(12 $\mu\text{m}$  semi-insulating epi GaN, known as “12 GaN”)



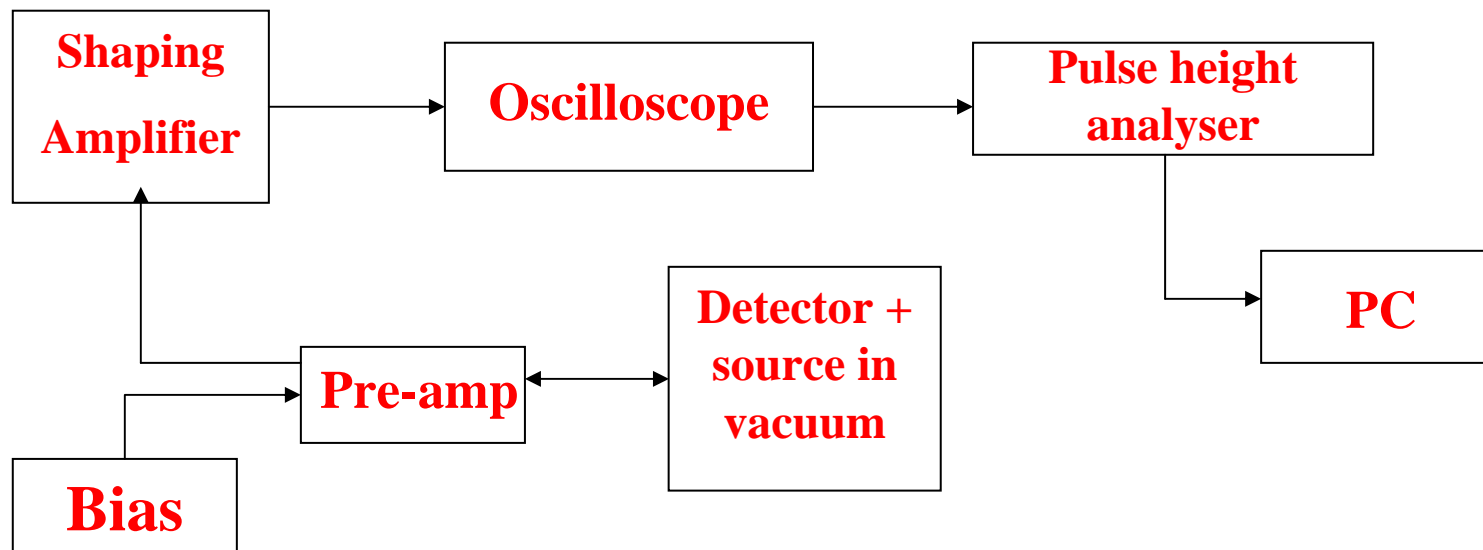
# Detector Fabrication

- Fabricated pad/guard ring structures using photolithographic techniques
- Samples 10 mm by 5 mm. Two Pad/guard ring structures per sample.
- Pad 1mm diameter. 50 $\mu$ m spacing between pad and guard ring. Guard ring 500 $\mu$ m wide
- Deposited 200 nm Pd to make Schottky contact. 200 nm Au on top of this to facilitate wire bonding
- Somehow needed to make a
- Coated side of material with



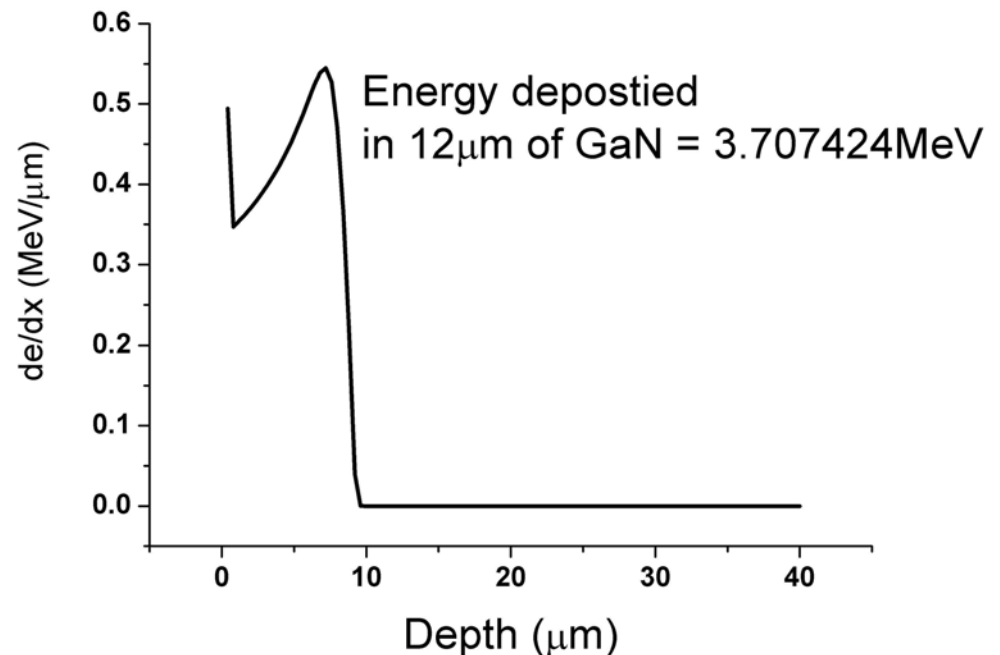
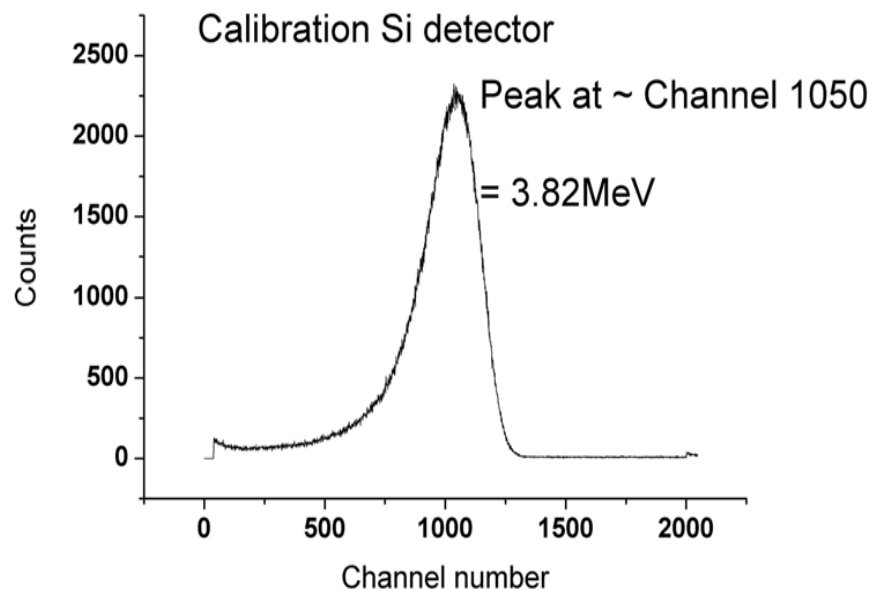
# Detector Characterisation

- Detectors characterised pre- and post- irradiation by performing
  - I-V measurements using a Keithley 237 measurement unit
  - CCE measurements using 5.48 MeV  $\alpha$  particles from an  $^{241}\text{Am}$  source
- All measurements performed at room temperature ( $\sim 23^\circ\text{C}$ )
- Detectors left in dark for  $\sim 2$  hours before performing I-V's.



# CCE Measurement

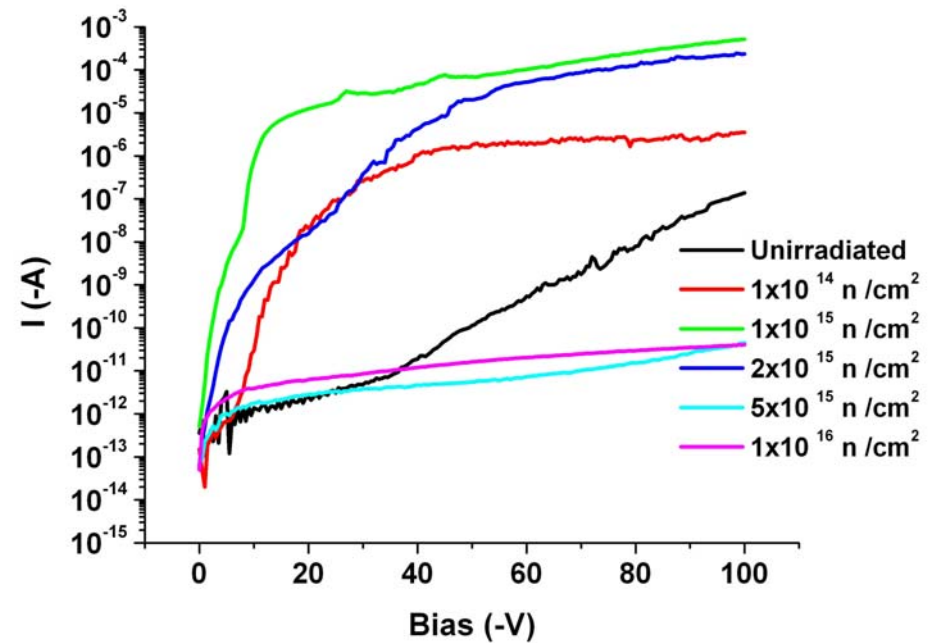
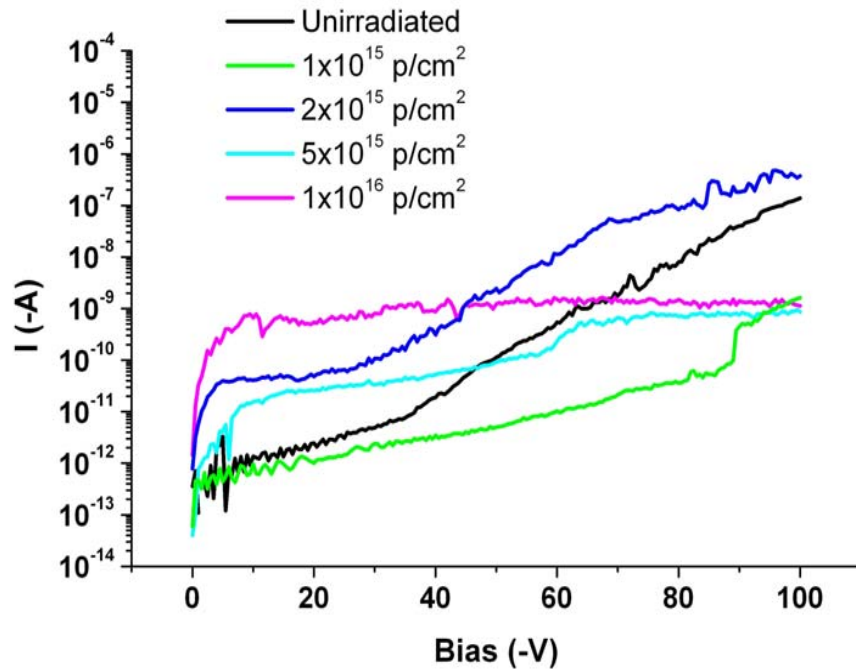
- We use a source with a large attenuation of the  $\alpha$  particles
- Need to establish energy of the emitted alpha particles
- From observed spectrum (below left) the energy of the  $\alpha$  particles emitted from our americium source is taken to be 3.82 MeV
- Then use SRIM simulation (below right) to calculate the amount of energy that should be deposited by an  $\alpha$  particle with incident energy of 3.82 MeV in 2.5  $\mu\text{m}$  / 12  $\mu\text{m}$  of GaN.
- Found to be 3.707MeV
- Also used 5.48 MeV  $\alpha$  particles from a second source to check results



# Irradiations Performed

- Detectors irradiated with 24GeV/c protons at CERN ( $1-3 \times 10^{13}$  p/cm<sup>2</sup>/hour) & neutrons at the TRIGA reactor in Ljubljana ( $5 \times 10^{12}$  n/cm<sup>2</sup>/s)
- 5 samples from each wafer = 30 samples irradiated.
- Detectors irradiated to fluences:
  - $1 \times 10^{14}$ /cm<sup>2</sup> (both proton and neutrons)
  - $1 \times 10^{15}$ /cm<sup>2</sup>
  - $2 \times 10^{15}$ /cm<sup>2</sup>
  - $5 \times 10^{15}$ /cm<sup>2</sup>
  - $1 \times 10^{16}$ /cm<sup>2</sup>
- Detectors stored at  $-20^{\circ}\text{C}$  after irradiation

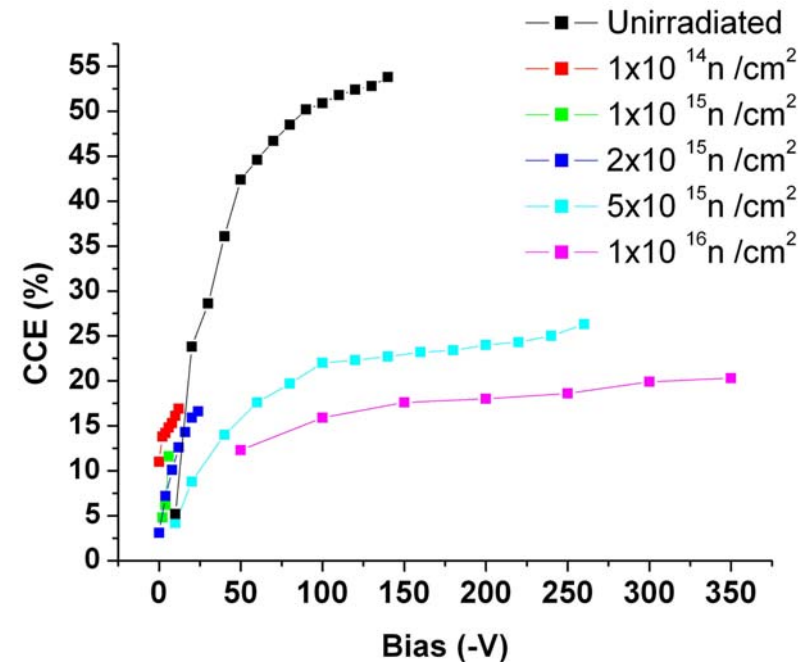
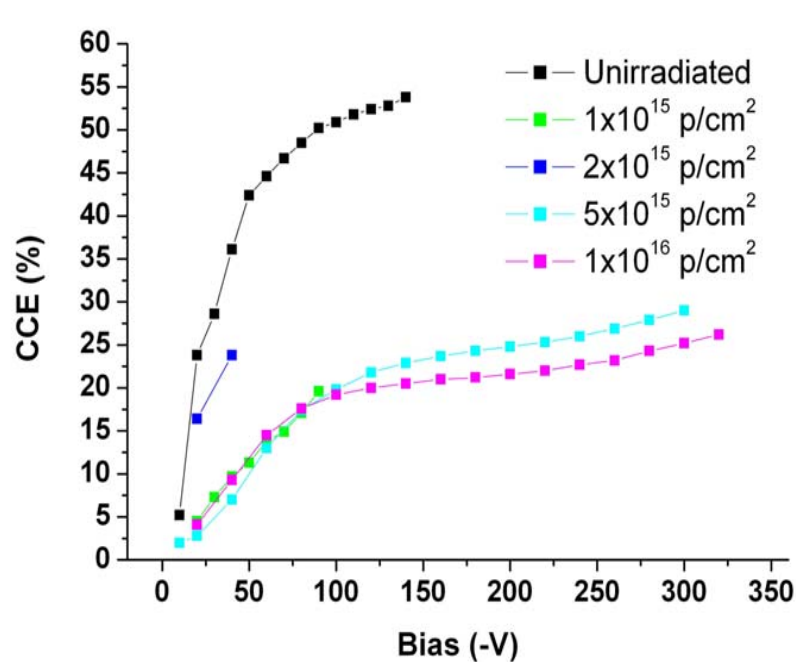
# I-Vs of Irradiated $12\mu\text{m}$ GaN



- Proton irradiations on left, neutron irradiations on right
- Detectors irradiated to fluences  $> 5 \times 10^{15}/\text{cm}^2$  show very low leakage current at a bias of  $-100\text{V}$



# CCEs of Irradiated 12 $\mu$ m GaN

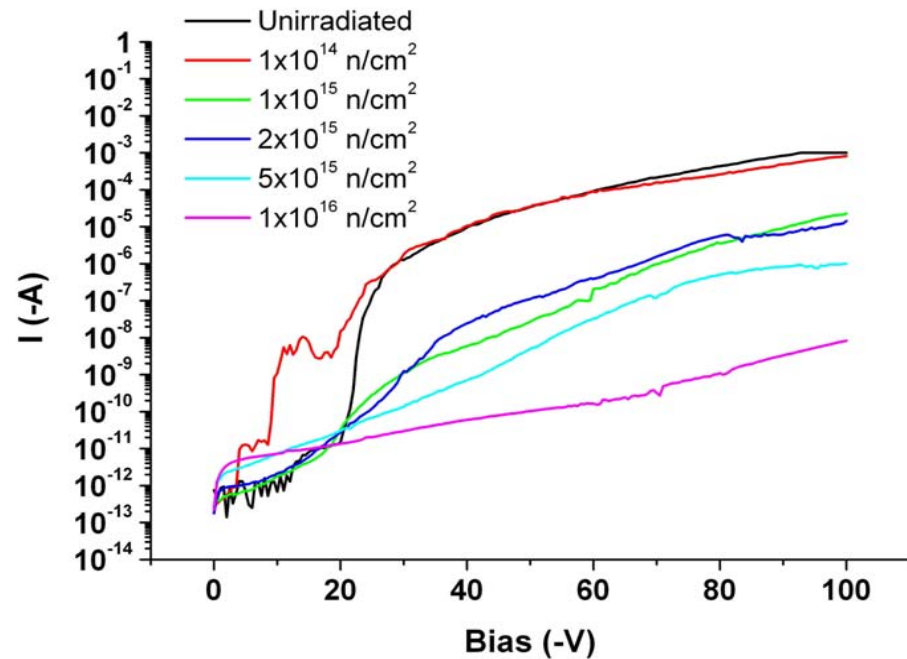
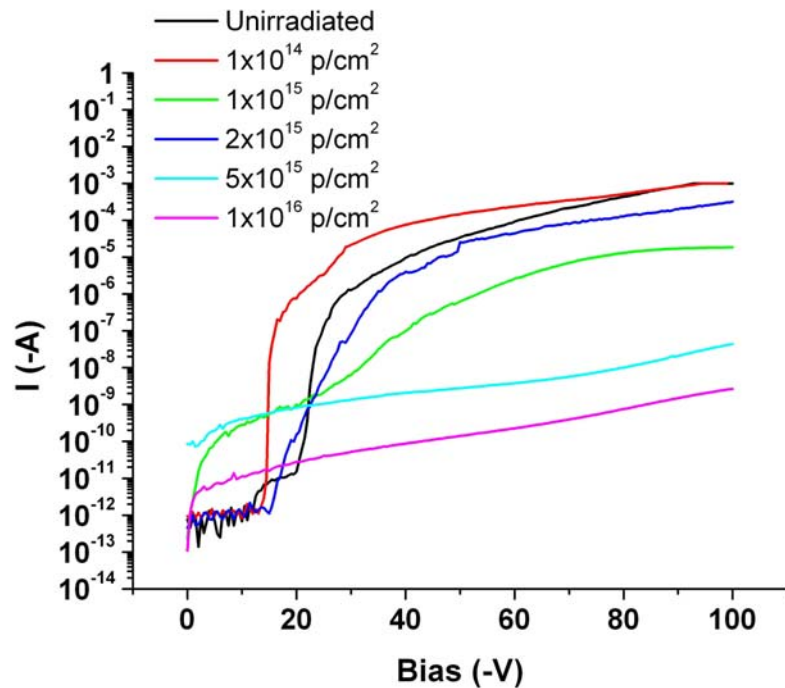


➤ Unirradiated  $CCE_{max} = 53\%$

➤ Large leakage current of some irradiated detectors results in CCE values only being available at small bias voltages e.g.  $10^{14}$ ,  $10^{15}$  &  $2 \times 10^{15}$  /cm<sup>2</sup>

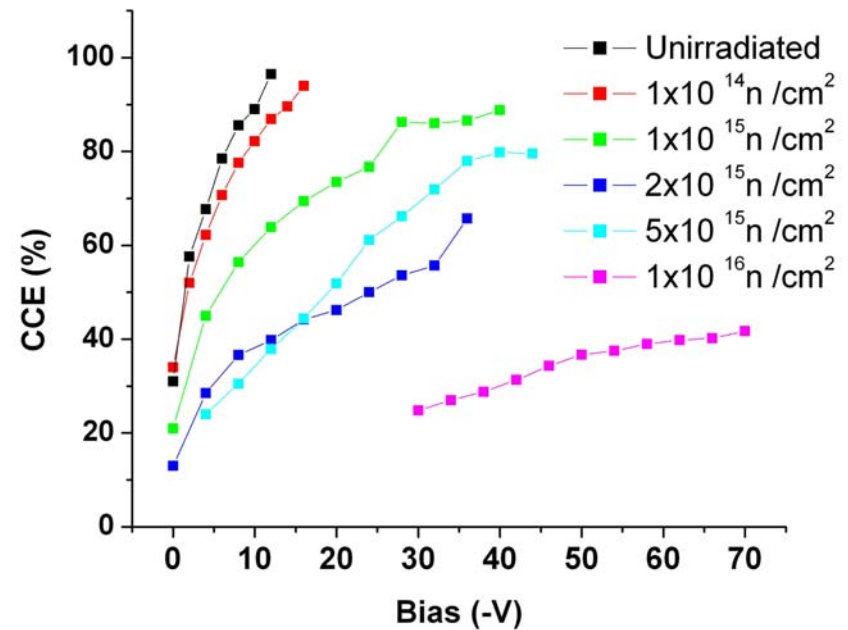
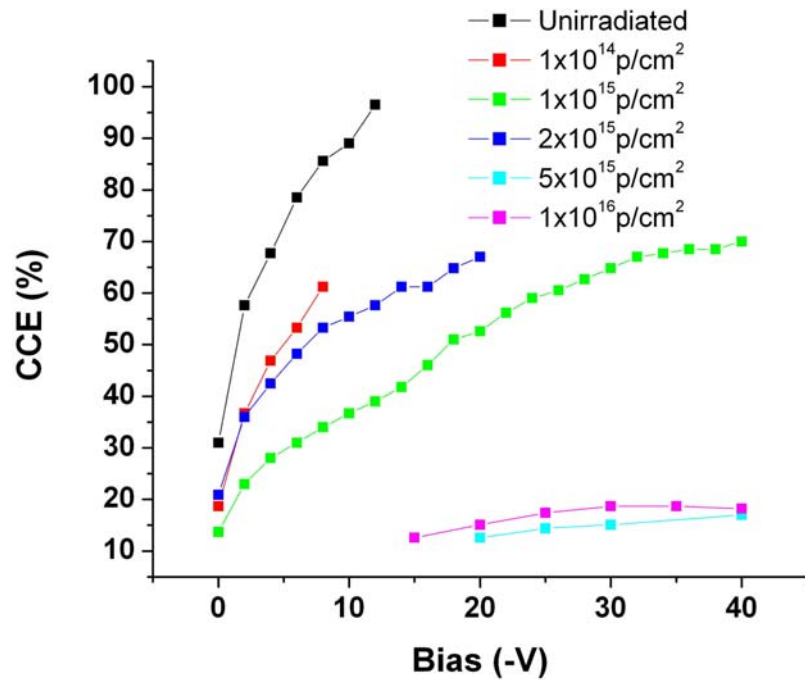
➤  $CCE_{max}$  drops to  $\sim 23\%$  after irradiation to  $10^{16}$  p/cm<sup>2</sup> & to 17% after irradiation to  $10^{16}$  n/cm<sup>2</sup>

# I-Vs of Irradiated 45 GaN



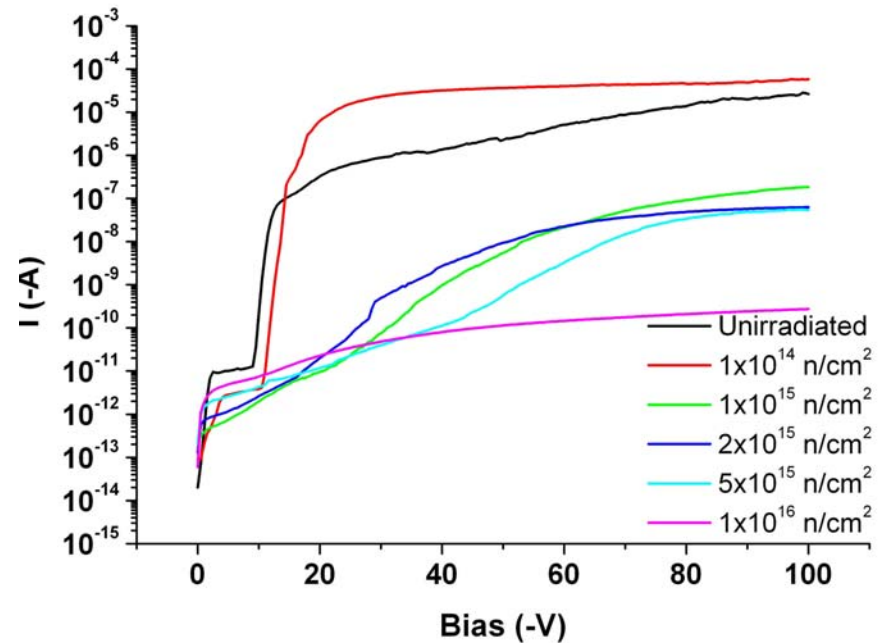
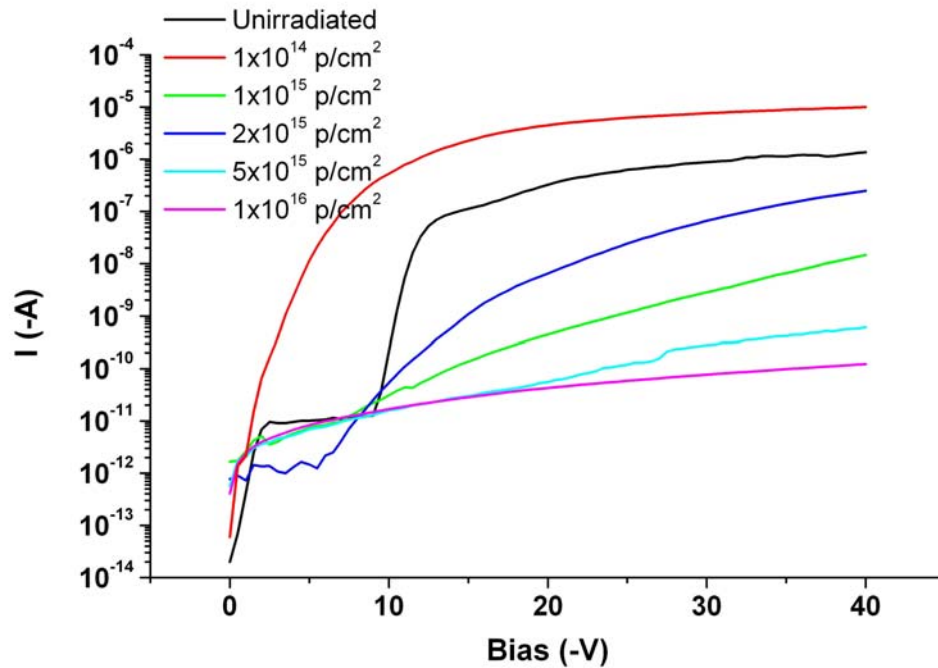
- In general, at reverse biases greater than 30V irradiated detectors show lower leakage current than unirradiated detector
- Detectors irradiated to fluences  $> 5 \times 10^{15}/\text{cm}^2$  again show very low leakage current at a bias of -100V

# CCEs of Irradiated 45 GaN



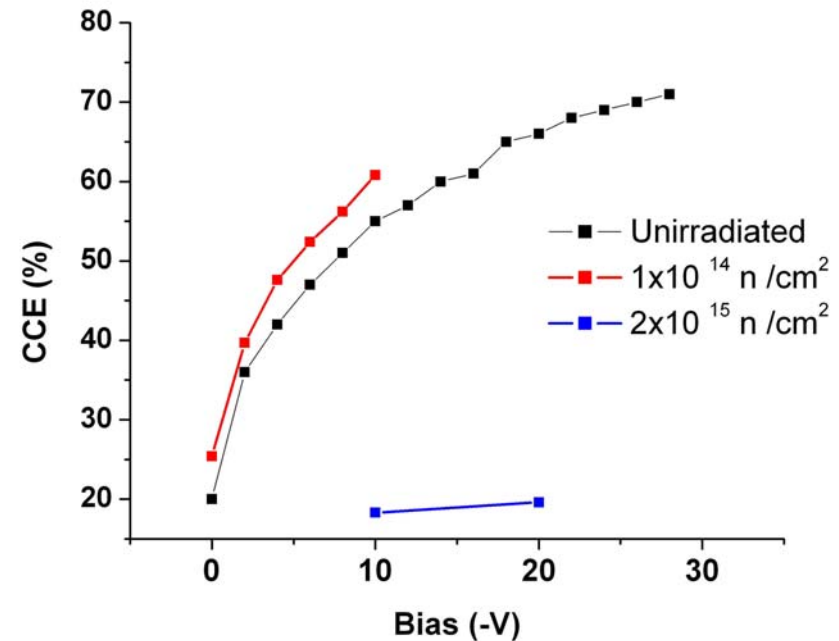
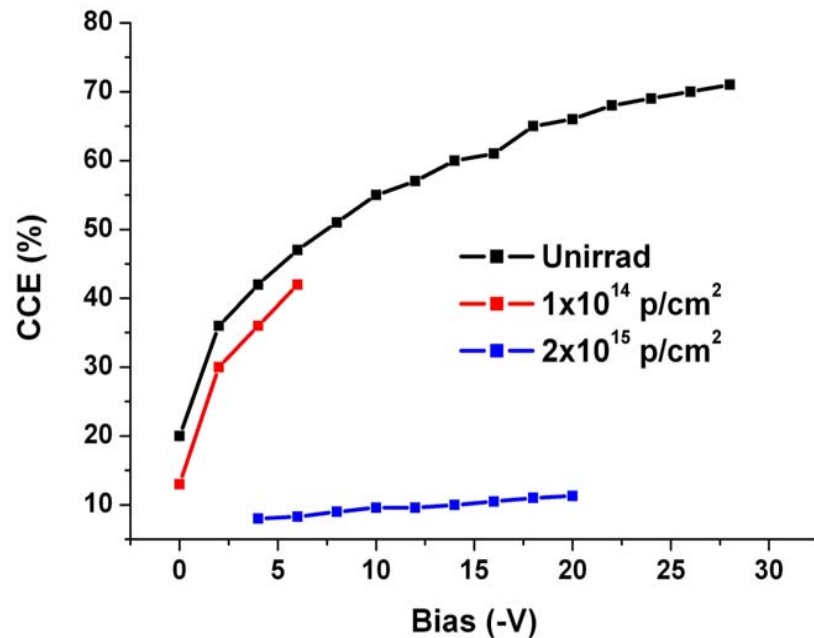
- Unirradiated  $CCE_{\max} = 97\%$
- $CCE_{\max}$  drops to  $\sim 20\%$  after irradiation to  $10^{16}$  p/cm<sup>2</sup> & to  $40\%$  after irradiation to  $10^{16}$  n/cm<sup>2</sup>

# I-Vs of Irradiated 36 GaN



- Again we see that the irradiations result in detectors exhibiting lower leakage current than the unirradiated detector (except  $10^{14}/\text{cm}^2$  irradiated detectors)
- Detectors irradiated to fluences  $> 5 \times 10^{15}/\text{cm}^2$  show very low leakage current

# CCEs of Irradiated 36 GaN



- No CCE measurements for  $1 \times 10^{15}/\text{cm}^2$ ,  $5 \times 10^{15}/\text{cm}^2$  &  $1 \times 10^{16}/\text{cm}^2$
- Unirradiated  $\text{CCE}_{\text{max}} = 70\%$
- $\text{CCE}_{\text{max}}$  drops to  $\sim 10\%$  after irradiation to  $2 \times 10^{15}$  p/cm<sup>2</sup> & to 20% after irradiation to  $2 \times 10^{15}$  n/cm<sup>2</sup>

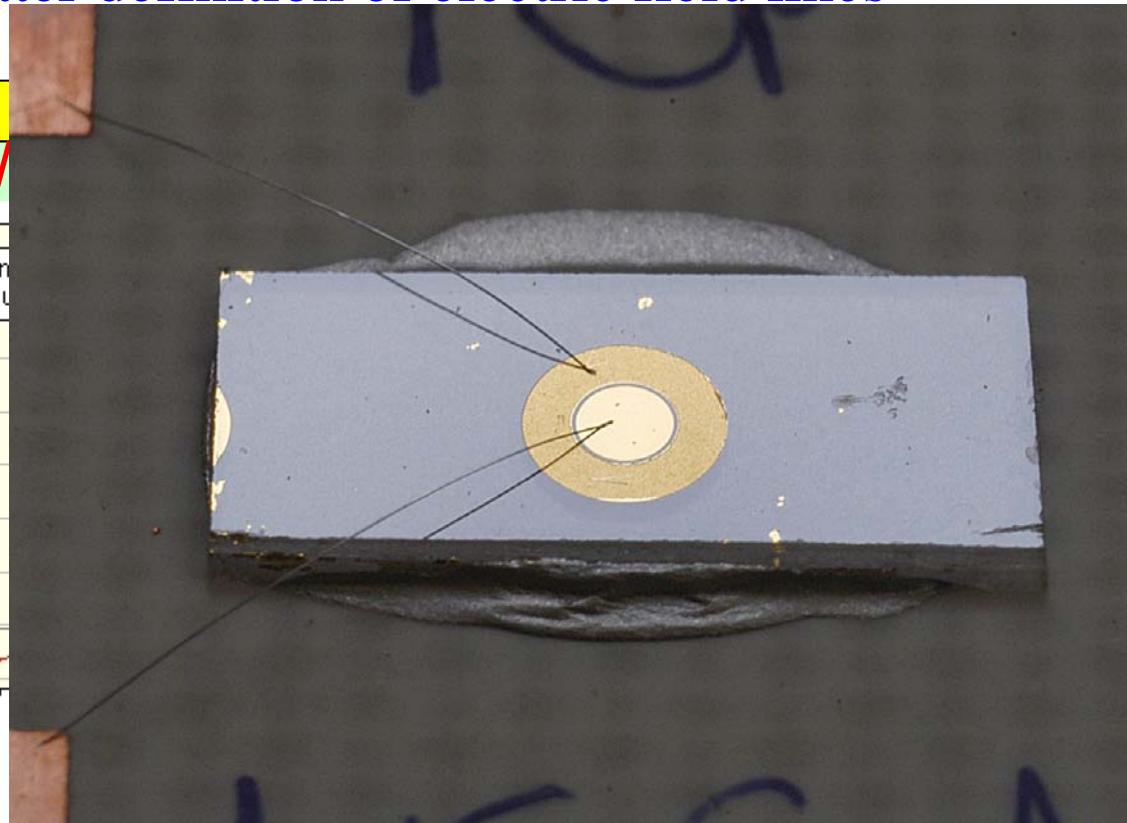
# ICP etching of GaN

- Schottky/ Schottky diode electric field lines are not well defined
- Would like to make contact to the n-GaN buffer layer



Better definition of electric field lines

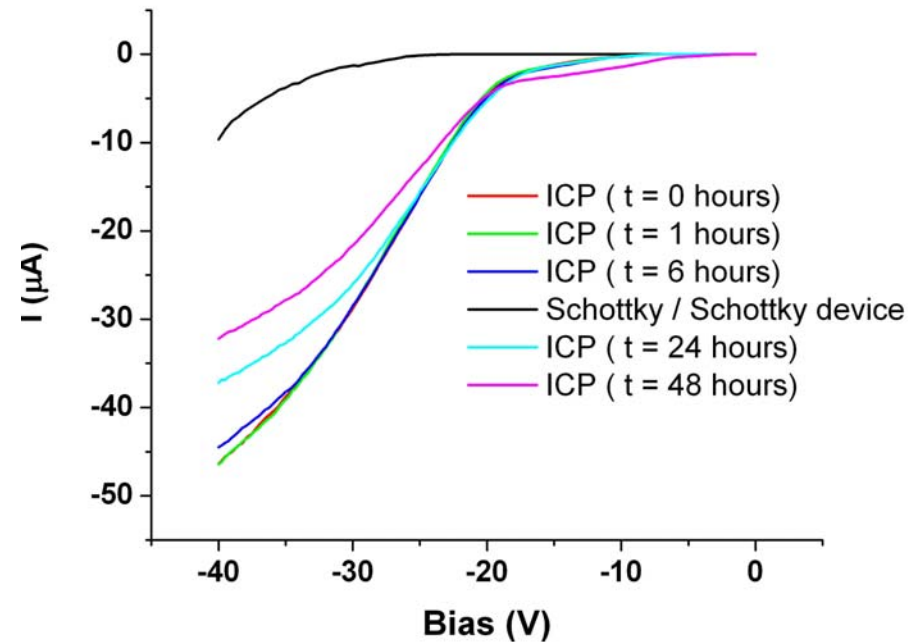
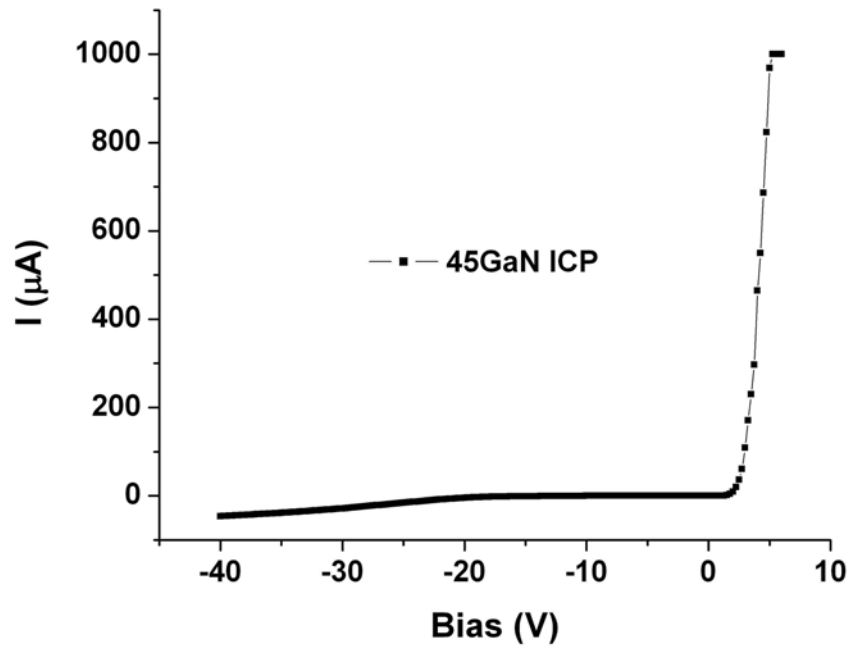
2.5-12um epi



um  
um  
um  
um  
um  
mrad  
mm  
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um<sup>2</sup>

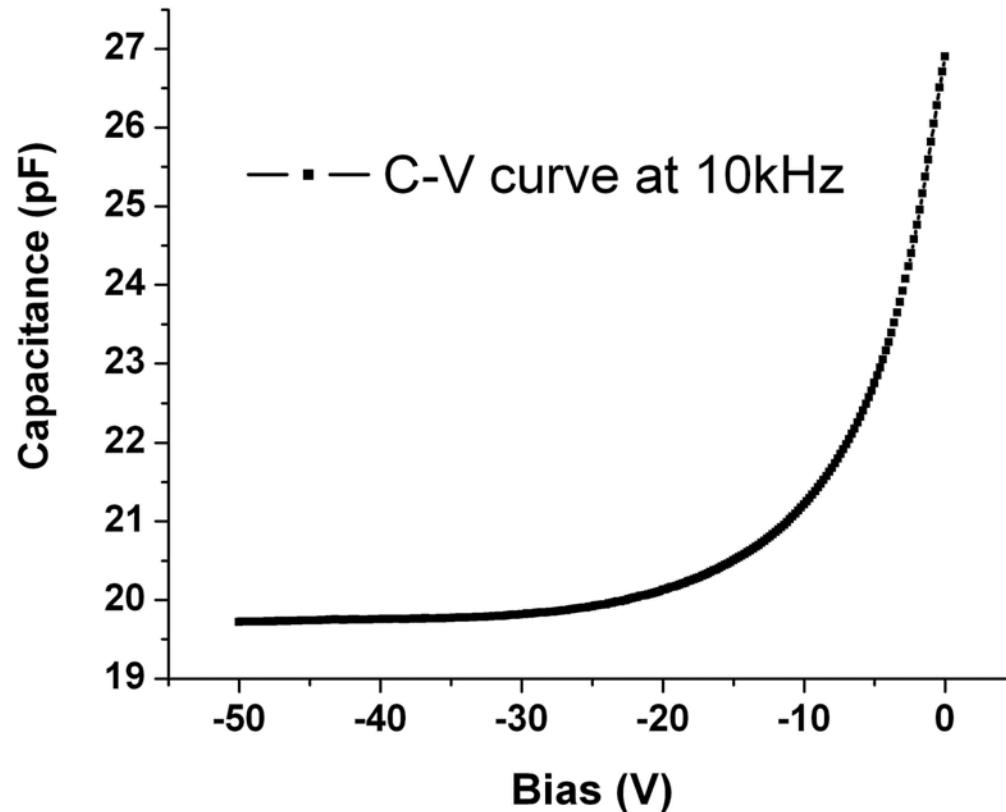


# ICP 45 GaN sample I-V Results



- GaN 45 sample etched October 2005
- Etch depth measured to be 3.5  $\mu\text{m}$  using interferometry
- Etching has increased leakage current

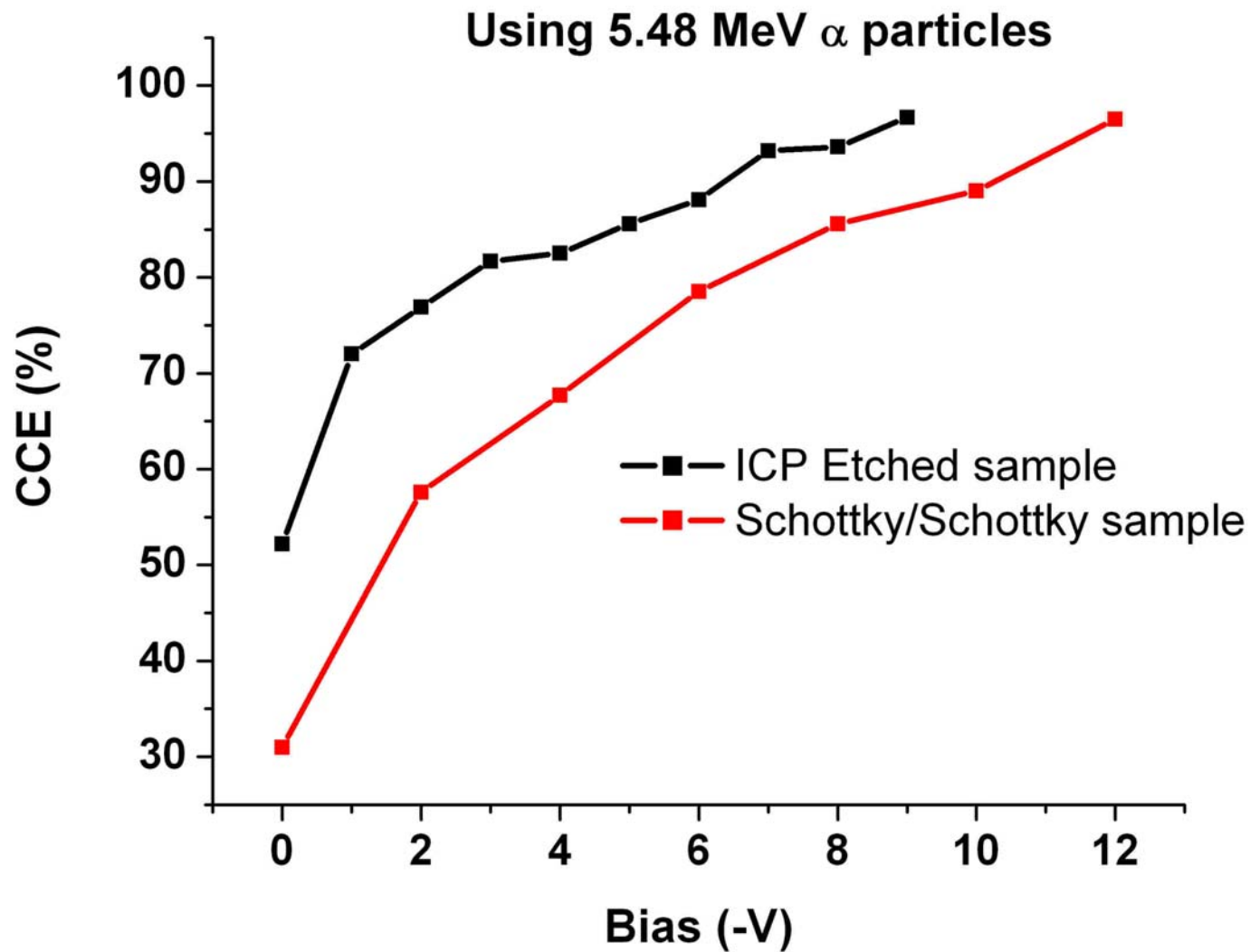
# ICP 45 GaN sample C-V Results



➤ First reliable C-V measurement I have made on GaN!

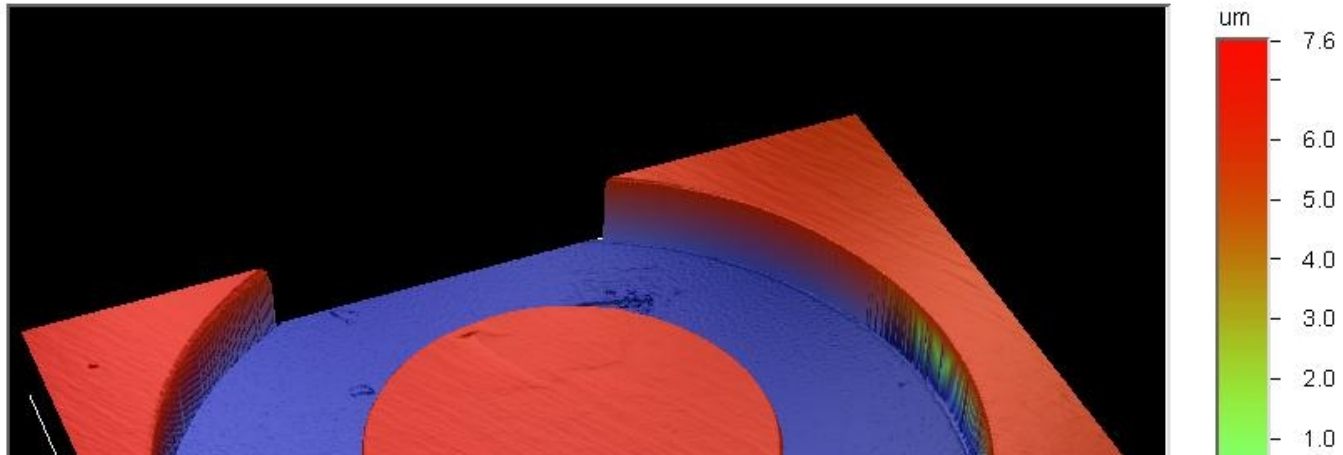


# ICP 45 GaN sample CCE



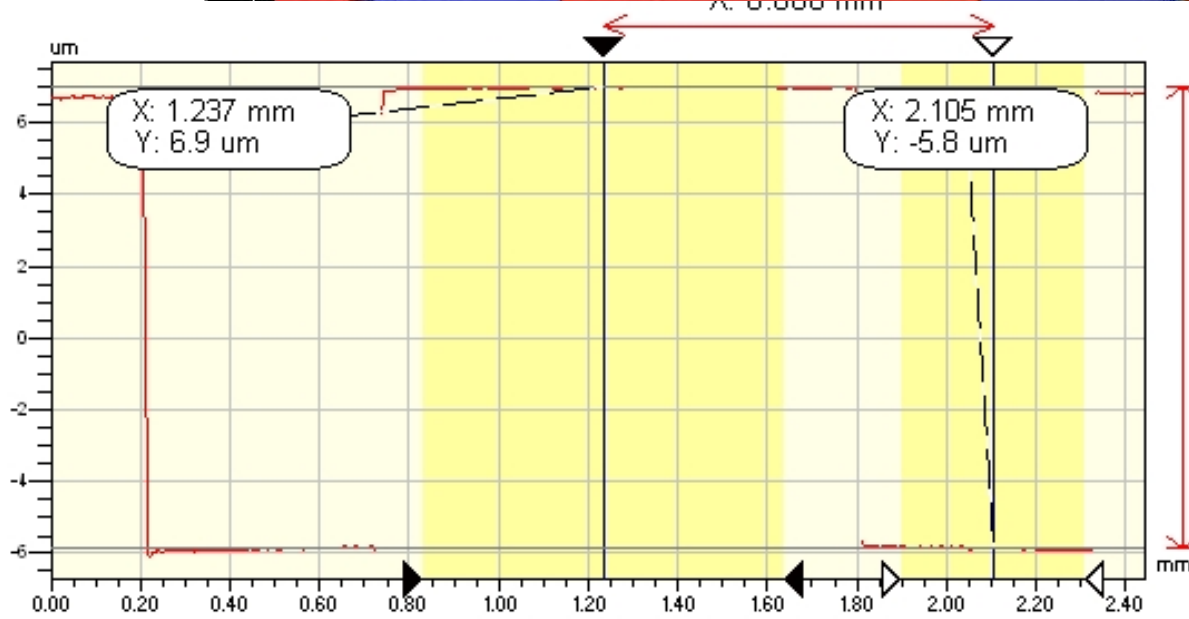
# Work in Progress

➤ We1



ast

➤



Y: 12.8 um

Rq	6.06 um
Ra	5.75 um
Rt	12.88 um
Rp	6.99 um
Rv	-5.88 um

Angle	-14.76 mrad
Curve	-13.83 mm
Terms	None
Avg Ht	2.58 um
Area	2239.75 um <sup>2</sup>

Y Profile

# Conclusion

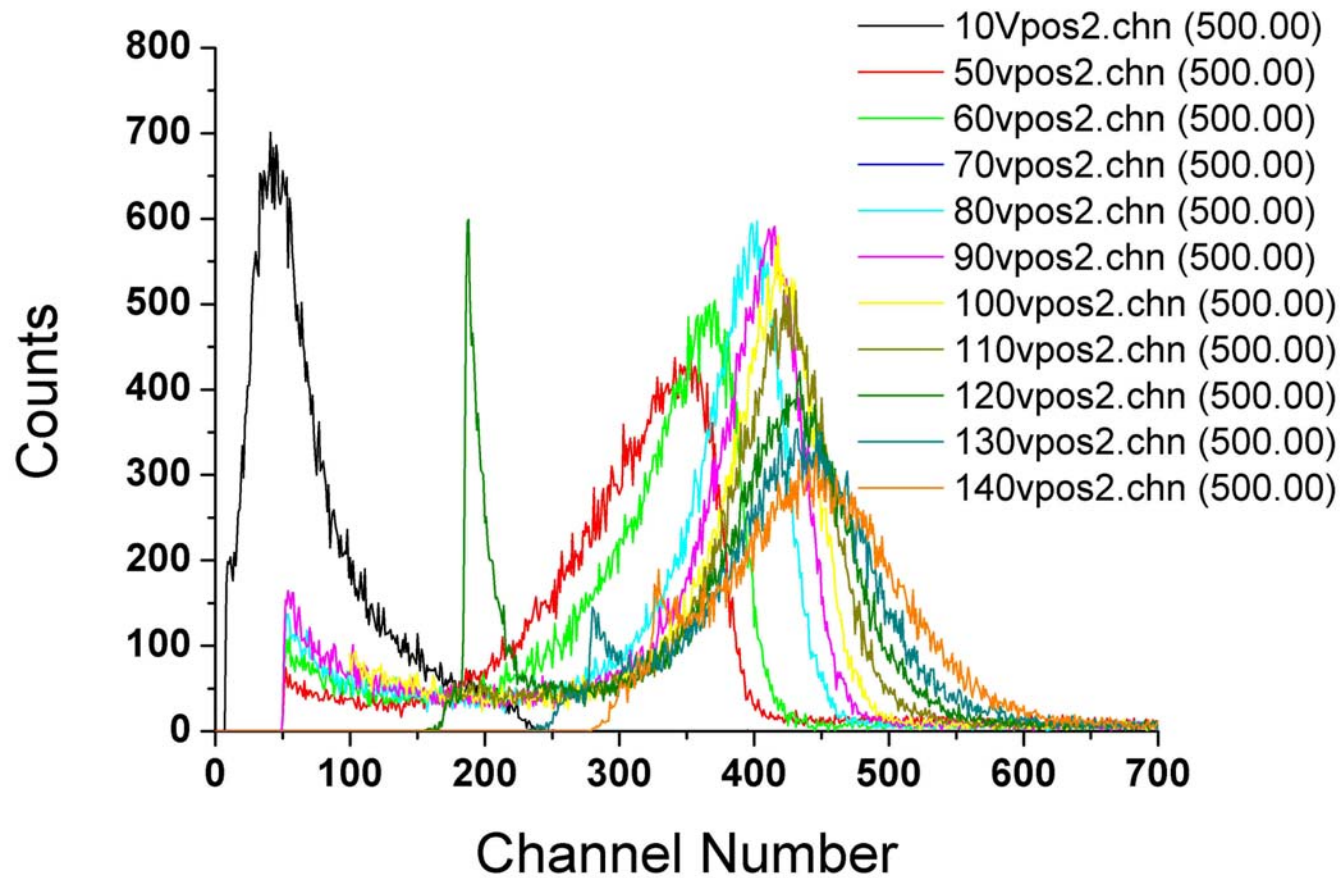
- Comprehensive study of GaN as a radiation hard material
- We have irradiated 3 different GaN materials ( 2 x 2.5um epi and 1x 12um epi) with protons and neutrons to various fluences
- Glasgow & Vilnius have characterised irradiated detectors by I-V, C-V, CCE, photoluminescence, microwave absorption, contact photoconductivity & thermally stimulated current techniques (see J. Vaitkus talk next)
- We have shown that thicker epi GaN has a  $CCE_{\max}$  of ~ 23% after  $10^{16}$  p/cm<sup>2</sup> & 17% after  $10^{16}$  n/cm<sup>2</sup>

Many thanks to Maurice Glaser and Federico Ravotti for performing proton irradiations

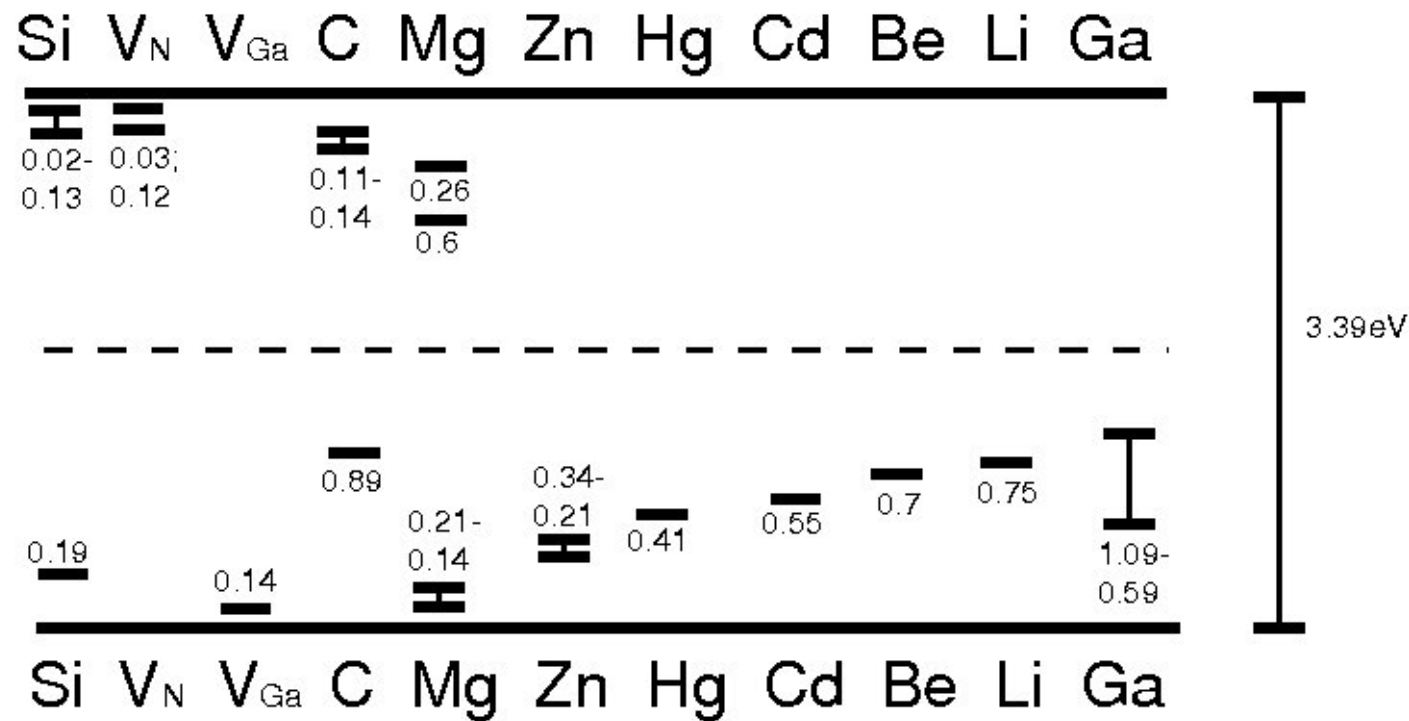
& to Gregor Kramberger for performing neutron irradiations

**Back up Slides**

# CCE Spectra

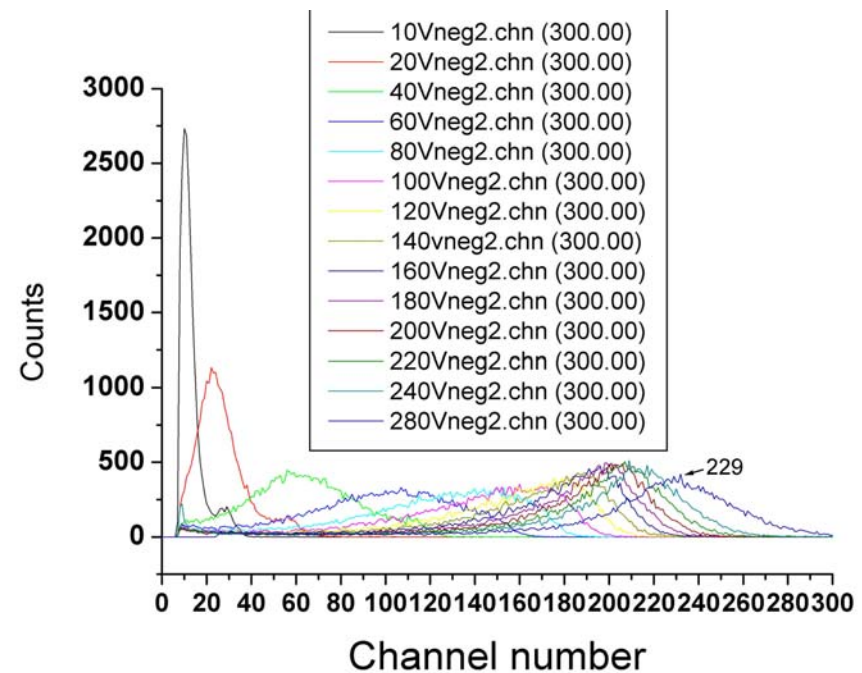
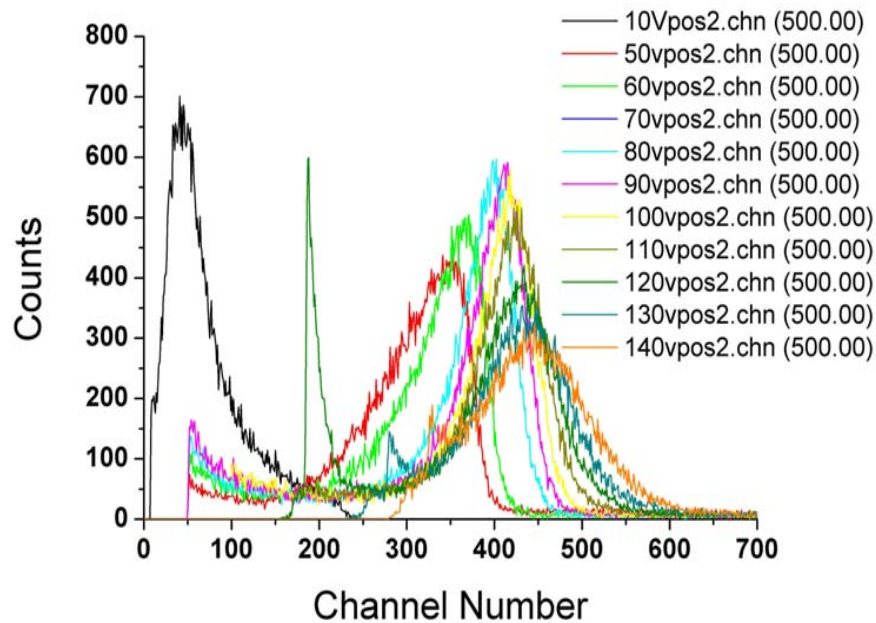


# Known Defects in GaN

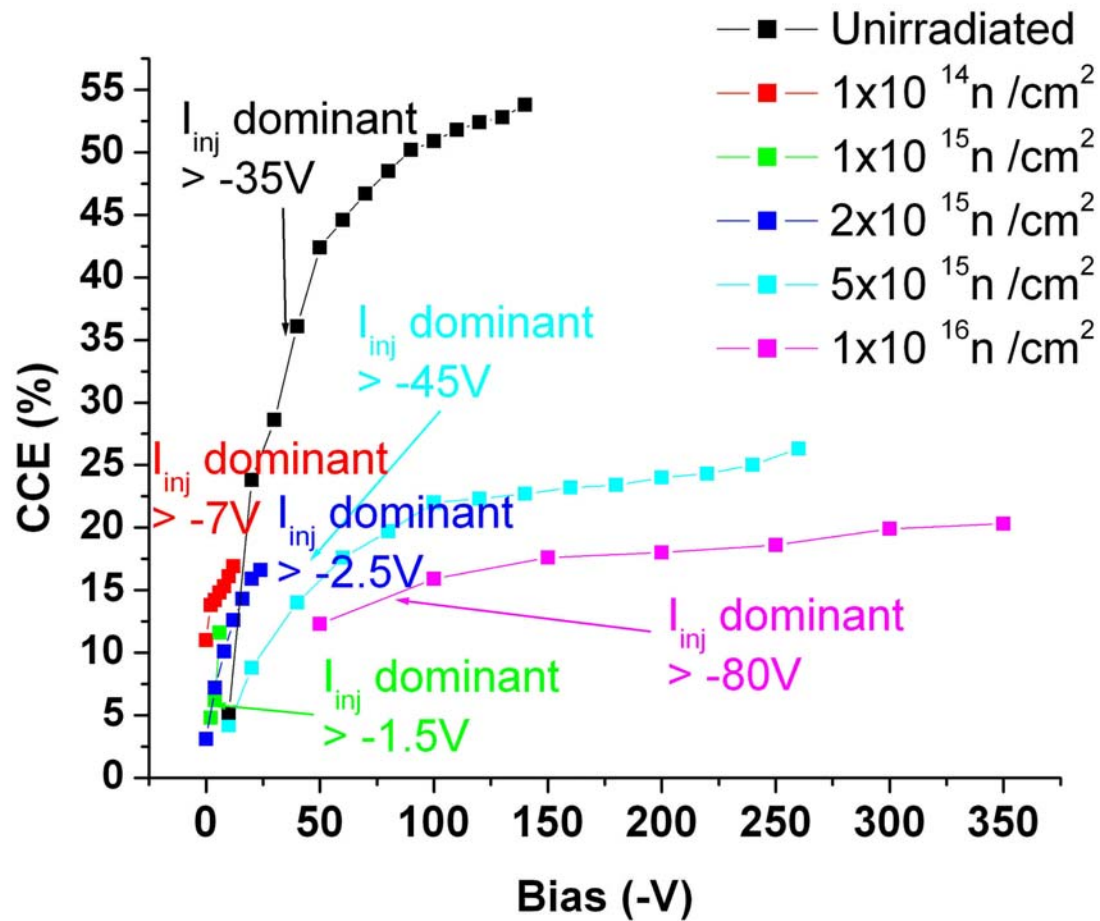


# CCE Spectra

- Spectra from an unirradiated detector shown on the left and from the detector irradiated to  $5e^{15}$ p/cm<sup>2</sup> on the right



# Injection Current



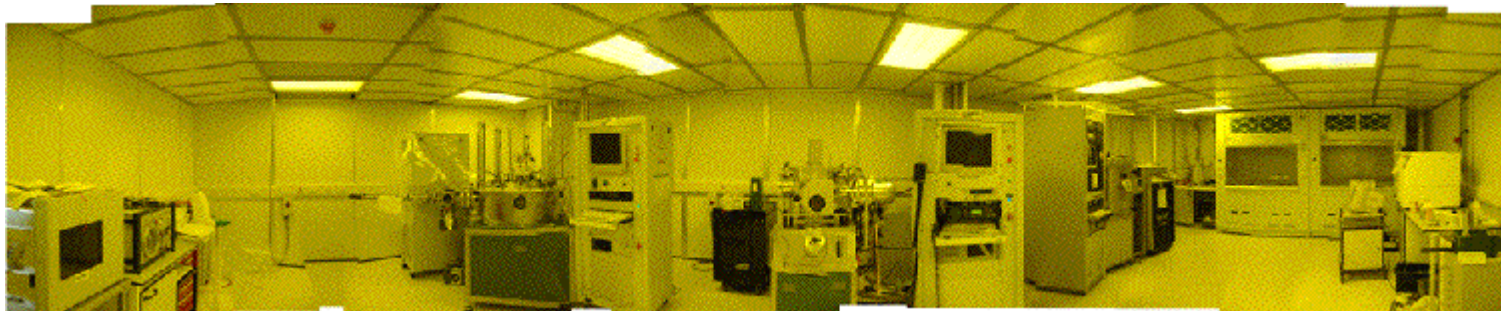


# Detector Fabrication

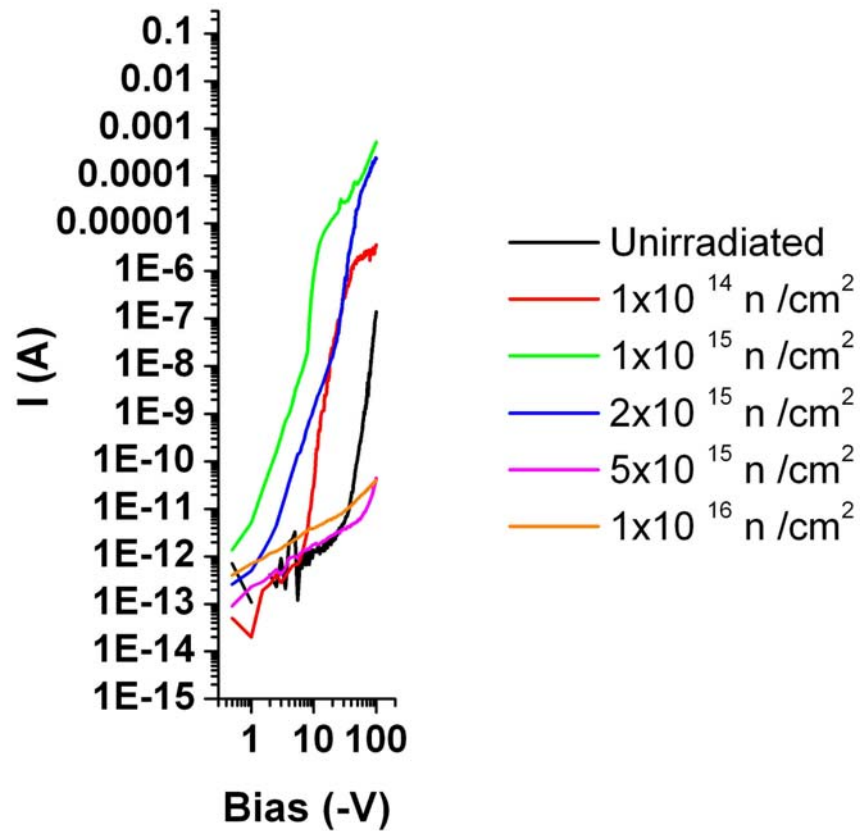
- Detectors fabricated using tools in the new £6 million cleanroom facility. Cabinets class 100, electron beam lithography room class 10



E-beam  
lithography  
3nm spot



# Injection Current 2



ICP etching : CH<sub>4</sub>/H<sub>2</sub> gas